



Integrated Device Technology, Inc.
2975 Stender Way, Santa Clara, CA - 95054

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: **L0308-03** DATE: 9/2/2003
Product Affected: IDTQS3VH16233

MEANS OF DISTINGUISHING CHANGED DEVICES:

- Product Mark
- Back Mark
- Date Code
- Other N/A

Date Effective: 9/2/2003

Contact: Bimla Paul
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Attachment: Yes No

Samples: Available upon request

DESCRIPTION AND PURPOSE OF CHANGE:

- Die Technology
- Wafer Fabrication Process
- Assembly Process
- Equipment
- Material
- Testing
- Manufacturing Site
- Data Sheet
- Other

**To correct Switching Characteristics for Vcc = 2.5V operation.
(There is no change in Vcc = 3.3V operation).**

Parameters	Old	Revised
TBX Switch Multiplex Delay SEL to xA	8ns max	9ns max
TPZH/TPZL Switch Turn-on Delay SEL to xBx	7.5ns max	9ns max
TPHZ/TPLZ Switch Turn-off Delay SEL to xBx	7ns max	7.5ns max
TPHZ/TPLZ Switch Turn-off Delay TEST to xBx	8ns max	8.5ns max

RELIABILITY/QUALIFICATION SUMMARY:

Data sheet change only. There is no change in quality and reliability of this product.

CUSTOMER ACKNOWLEDGMENT OF RECEIPT:

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.

IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: _____

Approval for shipments prior to effective date.

Name/Date: _____

E-Mail Address: _____

Title: _____

Phone# /Fax# : _____

CUSTOMER COMMENTS: _____

IDT ACKNOWLEDGMENT OF RECEIPT:

RECD. BY: _____

DATE: _____